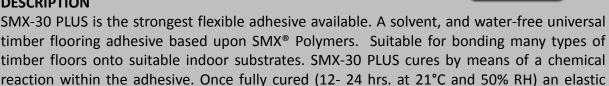
SMX-30 PLUS ADHESIVE



DESCRIPTION



The adhesive has excellent adhesion to most common substrates used in the construction industry. SMX-30 PLUS contains no water or solvents, minimising the risk of deforming the timber to a minimum. Suitable for subfloors with a residual moisture content up to 6% without the use of a moisture barrier due to the unique sealing capabilities.

and non-shrinking adhesive layer is formed, which is resistant to moisture and heat.

APPLICATIONS

Suitable for indoor bonding of all types of wooden floors such as solid, stab, pre-finished, and on-end parquet, wood-planks up to 18cm wide, wood-block and laminates. Suitable for use on porous and non-porous substrates such as mosaic, concrete, screeds, wood, chipboard, existing ceramic tiles, including floors with underfloor heating. SMX-30 PLUS is also extremely suitable for bonding moisture sensitive wood onto moderately porous surfaces.

FEATURES & BENEFITS

- Rapid cure & build up of final strength
- Walk on after 2 hr, sand after 12 hrs
- Forms stable peaks once applied
- No moisture barrier required (See Tech Data Sheet)
- Free of isocyanates, solvents & water





Colour	Size	Item Code
Light Oak	18kg (3x6kg foil bag)	120626
Light Oak	600ml	120625



